

FRED
Ultrafast Soft Recovery Diode, 80A/300V

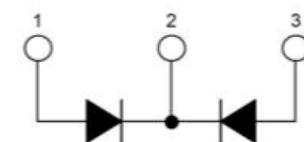
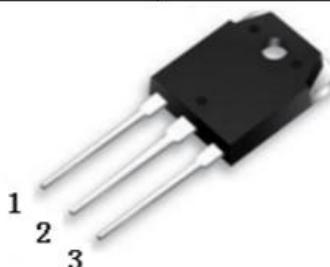
Description

These diodes are optimized to less losses and EMI/RFI in high frequency power conditioning system. The soft recovery character of the diodes offers buffer in most applications. These devices are suited for power converters and other applications where the switching losses are not significant portion of the total losses.

Features

- Ultrafast Recovery
- 175°C operating junction temperature
- High frequency operation
- Low IR value
- High surge capacity
- Epitaxial chip construction

Product Summary	
V _R	300 V
I _{F(AV)}	2*40A
t _{rr}	26ns



Application

- Inverter welding
- Switched mode power supply
- UPS

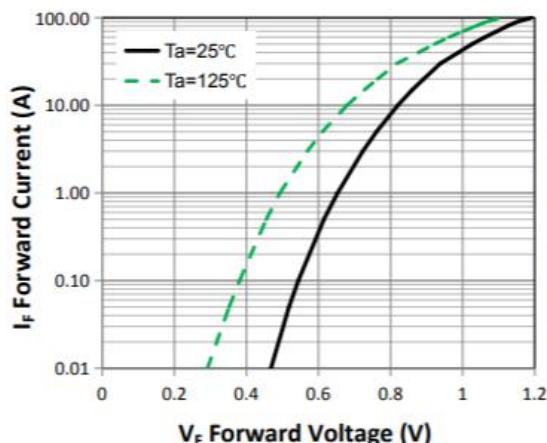
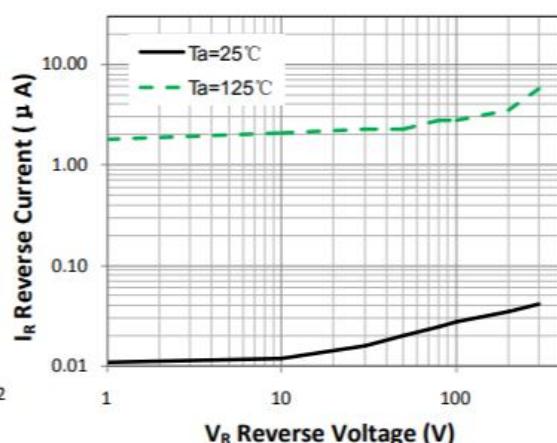
Absolute Maximum Ratings				
Parameter	Symbol	Test Conditions	Values	Units
Repetitive peak reverse voltage	V _{RRM}		300	V
Continuous forward current	I _{F(AV)}	T _C = 110°C	80	A
Single pulse forward current	I _{FSM}	T _C = 25°C	800	
Maximum repetitive forward current	I _{FRM}	Square wave, 20kHz	200	
Operating junction	T _j		175	°C
Storage temperatures	T _{stg}		-55 to +175	°C

Electrical characteristics (Ta=25°C unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ.	Max.	Units
Breakdown voltage Blocking voltage	V _{BR} , V _R	I _R =100μA	300			V
Forward voltage (Per Diode)	V _F	I _F =40 A		0.96	1.20	
		I _F =40 A, T _j =125°C		0.85	1.10	
Reverse leakage current(Per Diode)	I _R	V _R = 300V			20	μA
		T _j =150°C, V _R =300V			200	
Reverse recovery time(Per Diode)	t _{rr}	I _F =0.5A, I _R =1A, I _{RR} =0.25A			45	ns
		I _F =1A, V _R =30V, di/dt =200A/us		26	35	

Thermal characteristics

Symbol	Parameter	Typ.	Max.	Units
R _{θJC}	Junction-to-Case	—	0.75	°C/W

Typical Characteristics

Figure 1. Forward Characteristic(typ.)

Figure 2. Reverse Characteristic (typ.)